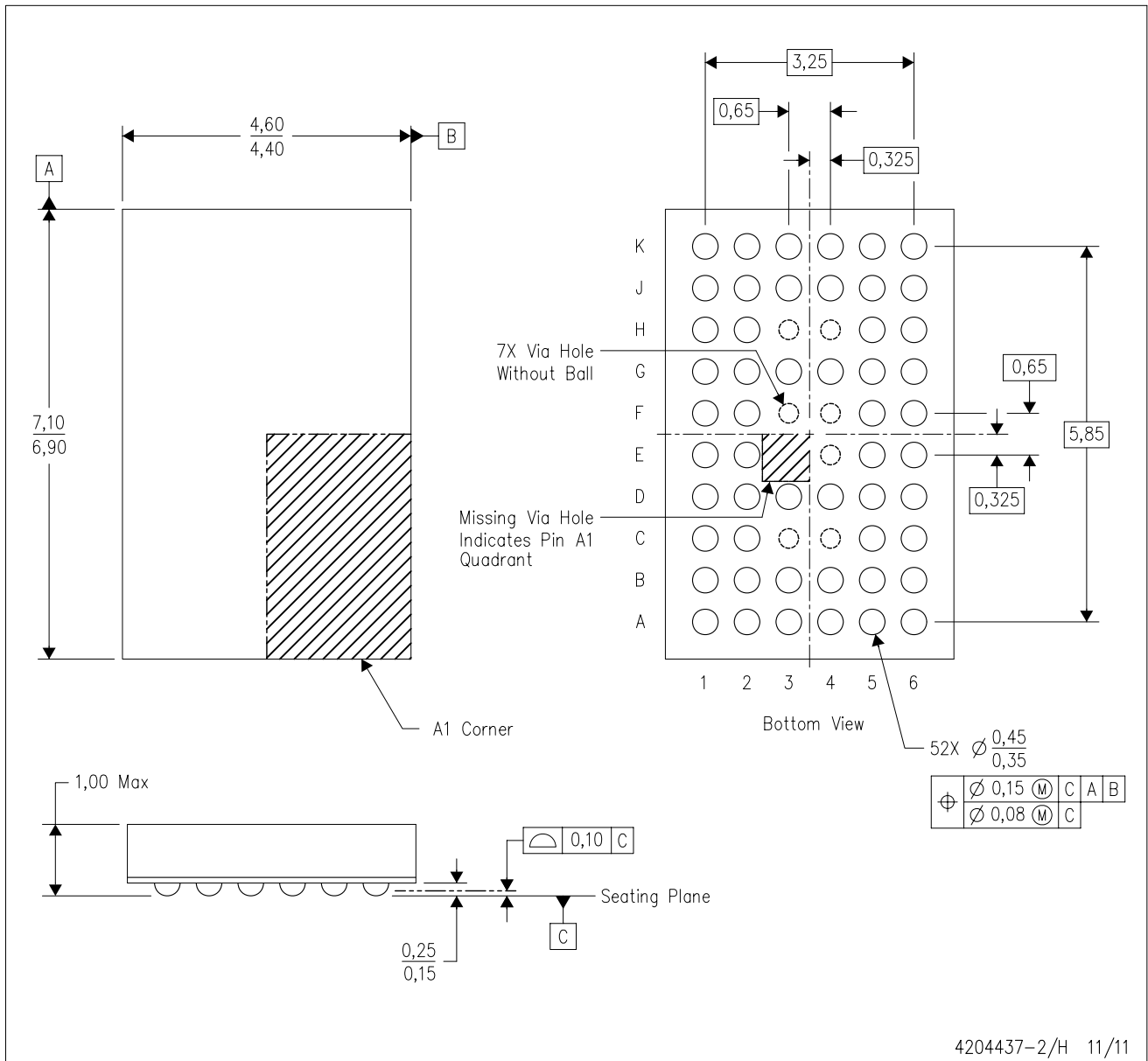


ZQL (R-PBGA-N52)

PLASTIC BALL GRID ARRAY



- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - Falls within JEDEC MO-285 variation BA-2.
 - This package is Pb-free. Refer to the 52 GQL package (drawing 4200583) for tin-lead (SnPb).

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